Case Docket No. MICRON.170A

Date: October 7, 2002

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In re application of:

Paul A. Farrar

App. No.

09/909,181

Filed

July 19, 2001

For

METHOD OF USING

FOAMED INSULATORS IN THREE DIMENSIONAL

MULTICHIP STRUCTURES

Examiner

Chris C. Chu

Art Unit

2815

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first class mail in an envelope addressed to: United States Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202, on

October 7, 2002

(Date)

Linda H. Lin, Reg. No 51,240

OCT 15 2002 TECHNOLOGY CENTER 2800

UNITED STATES PATENT AND TRADEMARK OFFICE P.O. Box 2327

Arlington, VA 22202

Sir:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated as shown below:

CLAIMS AS FILED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	26		32	= 0 ×	\$18	= \$0
Independent Claims	2		3	= 0 ×	\$84	= \$0
If application has been amended to contain multiple dependent claim(s), then add					\$280	= \$0
Time Extension Fee						\$0
				TOTAL ADD FOR THIS A		

- (X) Submission of Proposed Drawing Amendment for Approval by Examiner with 1-sheet of marked drawings
- (X) Return prepaid postcard.

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- (X) Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.
- (X) Please use Customer No. 20,995 for the correspondence address.

Registration No. 51,240 Attorney of Record Customer No. 20,995

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